# NIKKO POWER AMP





#### TYPE AND VOLTAGE

W-TYPE:	UL and CSA type	120V AC
E - TYPE :	NK-STD type	220V AC
B - TYPE :	BS type	240V AC

# SERVICE MANUAL

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### **SPECIFICATIONS**

#### AMPLIFIER SECTION

#### Continuous Power Output per Channel:

20~20k Hz (8Ω) >220 Watts >240 Watts  $20\sim20k$  Hz  $(4\Omega)$ 1kHz (8 $\Omega$ ) >240 Watts  $1kHz(4\Omega)$ >240 Watts

T. H. Distortion,  $8\Omega$ :

at Continuous Power Output **≯**0.008% at 1 Watt Power Output **≯**0.02%

T. H. Distortion,  $4\Omega$ :

at Continuous Power Output ≯0.02%

I. M. Distortion,  $8\Omega$ :

**≯**0.01% at Continuous Power Output at 1 Watt Power Output **≯**0.02%

IHF Power Bandwidth,  $8\Omega$ : 10Hz~700kz

Damping Factor at 1kHz,  $8\Omega$ : >80

Frequency Response

"NORMAL" input,  $8\Omega$ : 20Hz~100kHz +0, -1dB at 1 Watt Power Output

Input Sensitivity for 300 Watts Power Output:

MAIN IN 1V ±2dB

Signal to Noise Ratio, IHF A" Network:

MAIN (NORMAL, DIRECT) >115dB

Signal to Noise Ratio, DIN Filter:

MAIN IN (NORMAL, DIRECT) >90dB

> Channel Balance: ≯1dB

Residual Hum & Noise,  $8\Omega$ : ≯0.4 mV

> Idling Current: 50~150mA

Midpoint Voltage: 0 + 30 mV

Muting Delay Time:  $2 \sim 7$  seconds

GENERAL

Power Requirement:

W-TYPE AC 120V, 60Hz AC 220V, 50Hz E-TYPE AC 240V, 50Hz **B-TYPE** Power Consumption: 800W (1.25kVA) Ambient Temperature

-10~30°C during Operation:

Dimensions:

Width 482 mm (19 inches) Height 182 mm (7½ inches) 460 mm (181/8 inches) Depth Weight, without package: 21.5kg (47.3 lbs) Specifications are subject to change without notice.

#### DISASSEMBLY

#### Cabinet Cover Removal

- a. Remove 6 tapping screws from the top of the unit.
- b. Remove four screws from both sides of the unit.
- c. Lift the cabinet cover away from the unit.

#### Bottom Plate Removal

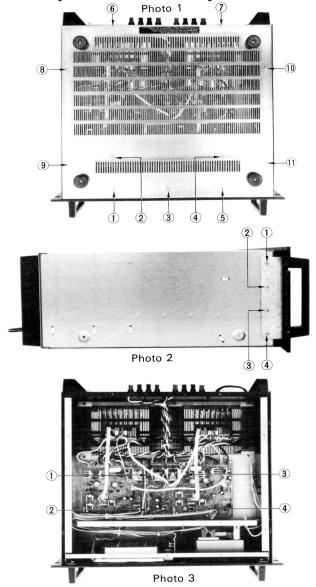
- a. Remove 11 tapping screws (#1- #11) from the bottom of the unit as shown in Photo 1.
- b. Lift the bottom plate away from the unit.

#### Front Panel Removal

- a. Remove 4 tapping screws (#1- #4) from the left side of the unit as shown in Photo 2.
- b. Similarly remove 4 tapping screws from the right side of the unit.
- c. Remove the front panel away from the unit by pulling it forward.

#### Power Transformer Removal

- a. Remove the cabinet cover & the bottom plate.
- b. Disconnect all the cables from the power transformer.
- c. Remove 4 nuts (#1- #4) from the chassis as shown in Photo 3.
- d. Lift the power transformer away from the unit.



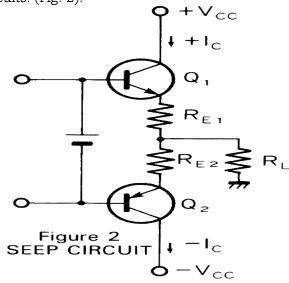
#### CIRCUIT DESCRIPTION

NIKKO's ALPHA 450, adopting latest devices such as  $\text{Hi-f}_{\text{T}}$  power transistors, is of a design introducing a variable bias circuit (non-switching circuit), a DC servo circuit & other most advanced techniques.

The following are explanations of the main circuits & devices.

#### Variable Bias Circuit

Currently, in the output stage of power amplifiers are mostly used SEPP (Single Ended Push Pull) circuits. (Fig. 2).



It is generally known that the current (idle current) flowing through NPN & PNP transistors of this circuit can be classified into three large groups of operation form, class "A", class "AB" & class "B". (Fig. 3).

In class "A" operation, neither of collector currents,  $Q_1$  &  $Q_2$  becomes zero nor cut off. Even when the current flowing to the load R is zero, a certain current is flowing through  $Q_1$  &  $Q_2$  & so no crossover distortion exists theoretically.

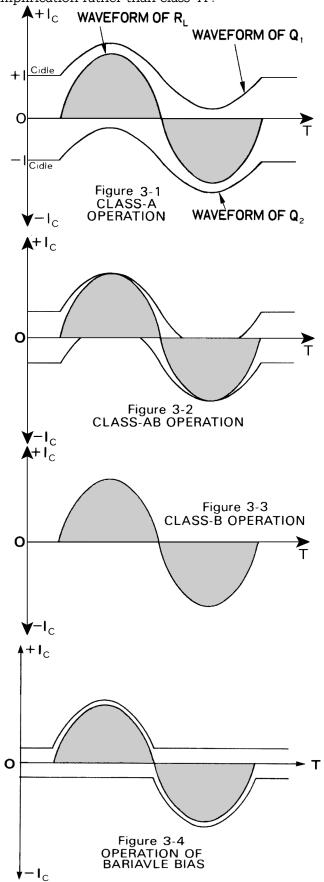
To realise perfect class "A" operation, however, a current equal to or more than maximum output should continue to be let flow at the output stage as idle current, causing class "A" operation to prove to be a poor efficiency system.

In class "AB" or "B" operation, the  $Q_1$  plays the role of amplification of the plus part of the signal &  $Q_1$  that of the minus part, no matter whether idle current is large or small.

In other words, there definitely exists a period in which, when one transistor is on, the other transistor keeps cutting off, in these operations.

Switching distortion or crossover distortion is caused at the moment of this active status turning into cutoff status or the cut-off status into the active status.

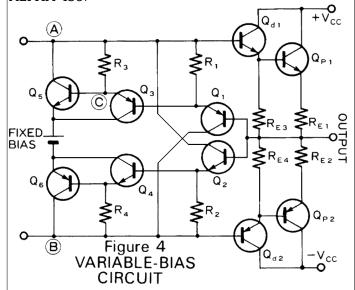
Nevertheless, as these operation forms have high efficiency with small idle current, it is much easier to use class "AB" or B operation for high power amplification rather than class "A".



A power amplifier enjoying the merit of each of these systems — that is, practically no crossover or switching distortion being caused in class "A" operation & easier high power amplification being achieved by class "B" — has been realised by adopting the variable bias circuit.

The idea of a variable bias circuit is -that in no case the output stage is allowed to be cut-off by increasing & decreasing bias voltage in corresponding with the voltage of input signal.

Fig. 4 shows the variable bias circuit adopted in ALPHA 450.



Now, suppose the + wave (plus part) of signal has been inputted, the currents of  $Q_{p1}$  &  $Q_{d1}$  increase & the voltage at both ends of  $R_{E1}$  &  $R_{E3}$  become high, resulting in a rise in the voltage between point (A) & OUTPUT.

At that time, the voltage at both ends of  $R_1$  &  $R_3$  becomes high because current flows  $R_1 > Q_1$  &  $R_3 - Q_3$ , causing the potential at (C) point to lower & the voltage of  $Q_5$  between collector & emitter to rise. As a result, the voltage between A & (B) rises &  $Q_{p2}$ , &  $Q_{d2}$  is kept from being cut-off.

From another point of view, the voltage drops at the emitter resistors  $R_{E1}$  &  $R_{E3}$  (these resistors are indispensable to protect transistors in stabilising bias of the output stage or at the time of abnormal current flowing) are cancelled by the drops at  $R_1$  &  $R_4$ , thus protecting  $Q_{p2}$  &  $Q_{d2}$  from becoming zero or anti-bias.

In the same manner, when the -wave (-part) of signal has been inputted, current flows  $Q_2$ - $R_2$  &  $Q_4$ = $R_4$ , resulting in a rise of  $V_{CE}$  at  $Q_6$ , thus protecting  $Q_{p1}$  &  $Q_{d1}$  from being cut-off.

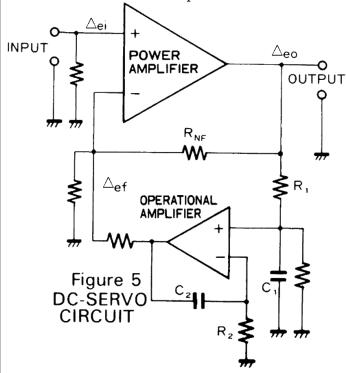
#### DC Servo Circuit

DC amplification is the most advanced form adopted for audio amplifiers as there is no phase lag over all the range from DC to audio frequency.

However, in a perfect DC amplifier (which is an amplifier having no coupling capacitors in its input part & NFB loop), a DC drift is caused in case a direct current is inputted or when the DC balance between each element has been lost due to temperature rise inside the amplifier.

The DC servo circuit is to suppress such a drift & realise a more stabilised amplifier.

The principle of a DC servo circuit is something like that of a comparator, in which changes in DC current between the output point & the ground is detected & drifts of the amplifier is controlled with their results used as the output of the servo circuit.



The basic elements are an integrating circuit composed of  $C_1$  &  $R_1$ , an operational amplifier & a mirror integrator composed of  $C_2$  &  $R_2$ . (Fig. 5).

Now, suppose a drift  $\Delta$ eo has been caused at the output of the power amplifier, a potential with the same phase  $\Delta$ ef is outputted at the output of the operational amplifier.

On the other hand, the initial stage of the power amplifier is a differential amplifier. When  $\Delta$ ef is inputted at its inverting input, the potential at the non-inverting input  $\Delta$ ei changes in the opposite direction of  $\Delta$ ef, resulting in a decrease of drift at the output of the power amplifier.

The DC servo circuit has a specific frequency characteristic. In the range of DC & ultra low frequency, gain of the power amplifier is kept at one over several tens of decibel, & in the audio frequency band, amplification at a certain gain can be made in the same manner as ordinary power amplifier.

The frequency on which the DC servo circuit starts to have effects is determined by the four elements,  $C_1$ ,  $R_1$ ,  $C_2$  &  $R_2$ .

#### Hi-f<sub>T</sub> Power Transistors

For details characteristics, refer to "SEMICONDUCTOR DATA" at the end of this manual.

The power transistors employed in ALPHA 450 realise an  $f_T$  (Current Gain-bandwidth Product) of 80MHz with NPN type & 60MHz with PNP type (each being a typical value) in spite of its high  $P_c$  (Collector Power Dissipation) such as 150W (The value when  $T_c$  = 25°C). Compared with conventional transistors with a Pc of 150W where  $f_T$  was around 10MHz at maximum, the high speed attained by these Hi- $f_T$  power transistors is remarkable.

Such high  $f_T$  has been realised specially by the inside construction of these transistors which is greatly different from that of conventional ones — the multi-emitter construction.

In this construction, the emitter inside the transistor is divided into many units & emitter resistors with small resistance are inserted to each unit, resulting in a parallel connection.

This equivalently means that many small signal transistors with high  $f_{\text{T}}$  & switching speed are connected in parallel , which has made it possible to realise such a high power characteristic while maintaining high switching speed.

Thanks to such construction as mentioned above, these power transistors are excellent in linearity of its  $h_{\rm fe}$ .

Furthermore, as dissipation is dispersed equally to each emitter due to the emitter-divided construction, they have another feature of being strong against breakdown as compared with conventional power transistors.

#### ALIGNMENT

#### Alignment Precautions

1. As the ALPHA 450 is a power amplifier with large output power, it consumes much electrical power & a great amount of current flows in the power source line of the primary side. Therefore, in the case when it is connected to the source by an extension cord, the size of the extension cord should be equal or larger than that of the power source cord of the ALPHA 450. Otherwise, the voltage might be reduced or the extension cord might generate excessive heat because of the resistance which the cord has, then not only can proper alignment be done, but also it is very dangerous.

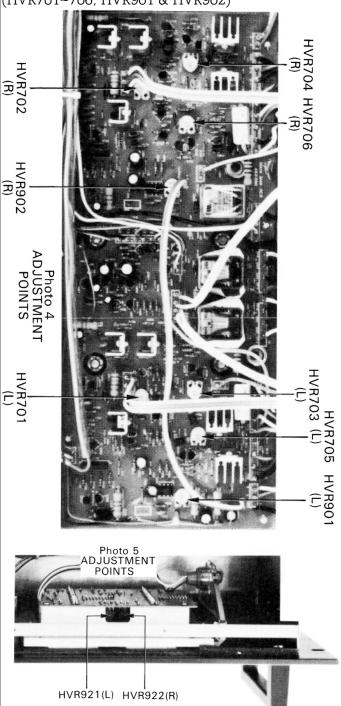
- 2. If the power sources are supplied to the ALPHA 450 & the instruments by branching off from one cord, the voltage is sometimes dropped down & the stability of the instruments goes down. The ALPHA 450 & the instruments should be connected to the power sources by using independent cords. The ALPHA 450 must take the power source from AC outlet of the wall side.
- 3. As there are many parts which hold high voltages in the circuit & the parts inside of the ALPHA 450, be careful not to receive an electric shock. In the case of connecting & taking off the instruments, you must turn off the power switch of the ALPHA 450 before getting on the work.
- 4. When the circuit happens to be shorted by the drivers or test probes used for alignment through mistake, the circuit & the parts will be damaged. As the damage is larger than that of ordinary amplifiers & receivers, close attention is needed. It is advised that the screw driver, excluding the top part, should be wrapped with insulation tape or a driver made of plastic or some kind of insulating material should be used.
- 5. As the dummy load resistor generates heat while alignment, it gets very hot & you may be burnt if you touch it with bare hands. It's better if you can put the dummy load resistor in a place away from being touched, but the wire between the dummy load resistor & the amplifier should not be long. Contrive some method, like putting the dummy load resistor in a well ventilated box. Further, as >10A current might flow in the wire connecting the dummy load resistor & the amplifier, at least larger than AWG #18 thick wire should be used.
- 6. The slide switch near the "INPUT LEVEL" volume on the rear panel of the amplifier is to be set in the "NORMAL" position. All the adjustments in the following should be done after the slide switch is set in the ""NORMAL" position.

#### Test Equipment

Allow a minimum of 10 minutes warm-up for test equipment.

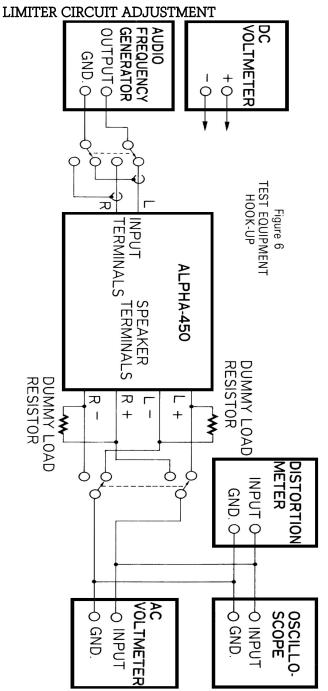
Maintain rated line voltage. Audio Frequency Generator Distortion Meter Oscilloscope AC Voltmeter DC Voltmeter 2-Dummy Load Resistors,  $8\Omega$ , 500W 2-Dummy Load Resistors,  $4\Omega$ , 500W

All the semi fixed resistors of the MAIN AMP PCB are set around the centre position temporarily. (HVR701~706, HVR901 & HVR902)



#### DC BALANCE ADJUSTMENT

- 1. Connect  $8\Omega$  dummy load resistors to the left & right channel speaker terminals.
- 2. Turn the "INPUT LEVEL' volume controls down to the fully counter clockwise, & set it to "MIN".
- 3. Turning on the power switch of the ALPHA 450.
- 4. Adjust the semi-fixed resistor R901 (left-ch) or R902 (right-ch) for a 0V ±5mV on DC voltmeter.
- 5. Turning on the power switch, till the DC balance settled down. This takes about 10 minutes. So after adjustment, keep the power switch for 10 minutes, then make sure the DC balance again.
- 6. Turning off the power switch. Remove the DC voltmeter &  $8\Omega$  dummy load resistors.



NOTE: Fig 6, for test equipment hook-up.

- 1. Connect  $4\Omega$  dummy load resistors to the left & right channel speaker terminals.
- 2. Connect the AC voltmeter, distortion meter & the oscilloscope to the left (right) channel speaker terminals. Connect the generator to left (right) channel input terminal.
- 3. Turning on the power switch of the ALPHA 450.
- 4. Turn the "INPUT LEVEL" volume control fully clockwise, & set it to "MAX".
- 5. Set the frequency of the generator to 1kHz. Adjust the output level of the generator so as to make the output power 260W. (32.5VAC voltmeter reading.)
- Adjust the semi-fixed resistors HVR703~HVR706 so that the upper & the lower side peaks of the output waveform begin to clip. (HVR703 & 705 are for the left-ch, HVR704 & 706 for the right.)
- 7. Turning off the power switch. Remove  $4\Omega$  dummy load resistors.

#### IDLING CURRENT ADJUSTMENT

- 1. Connect the  $8\Omega$  dummy load resistors to the left & right-ch speaker terminals. Connect the DC voltmeter across the wiring terminals No. 16 & 17 (left-ch) or No. 35 & 36 (right-ch on the MAIN AMP PCB.
- Turning on the power switch of the ALPHA 450. Adjust the semi fixed resistor HVR701 (left-ch) or HVR702 (right-ch) so that the DC voltmeter indicates 18mV ±1mV.
- 3. Turn off the power switch of the ALPHA 450 & remove the DC voltmeter &  $8\Omega$  dummy load resistors.

#### POWER LEVEL INDICATOR ADJUSTMENT

NOTE: Fig 6, for test equipment hook-up.

- 1. Connect  $8\Omega$  dummy load resistors to the left & right-ch speaker terminals.
- 2. Connect the AC voltmeter, distortion meter & the oscilloscope to the left (right) channel speaker terminals. Connect the generator to left (right) channel input terminal.
- 3. Turning on the power switch of the ALPHA 450.
- 4. Turn the "INPUT LEVEL" volume control fully clockwise, & set it to "MAX".
- 5. Set the frequency of the generator to 1kHz. Adjust the output level of the generator so as to make the output power 170W. (37VAC voltmeter reading.)
- 6. Adjust the semi-fixed resistors HVR921 (left-ch) & HVR922 (right-ch) of the LEVEL INDICATOR PCB so that the LED of "200W" dimly lights up.
- 7. Turning off the power switch of the ALPHA 450.
- 8. Remove all test equipment.

#### Power Transistors Mounting Assembly

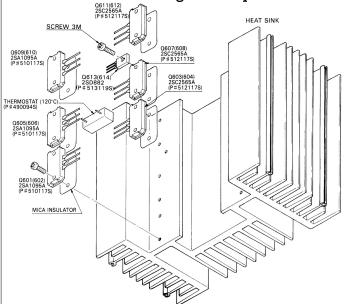
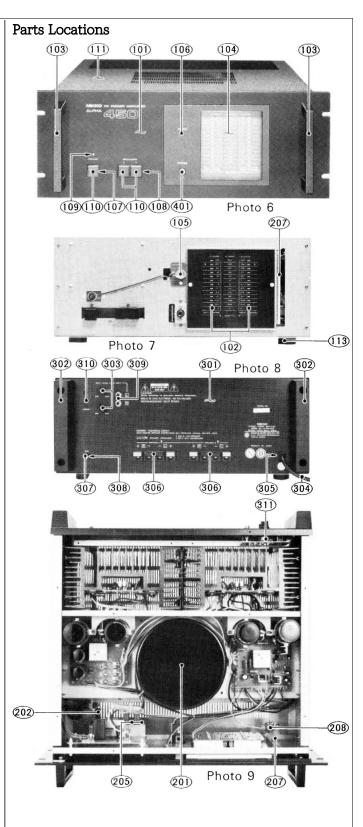


Figure 9 NOTE: For best heat conduction, use thermally conductive silicon grease between the power transistor and the mica insulator and between the insulator and the heat sink.



#### Precautions For Repair Service

Many of these items are included just as a reminder—they are normal procedures for experienced technicians. Short-cuts can be taken: but, often they cause additional damage to transistors, circuit components or the printed circuit board.

- Do not bridge electrolytic capacitors with AC power. The resultant surges may damage solid state devices.
- 2. Do not bias the base of any transistor while voltage is being applied to its collector.
- Replacements for output and driver transistors, if necessary, must be made from the same hfe group as the original type. Be sure to include this information when ordering replacement transistors.
- 4. If one output transistor burns out (open or shorts), always remove all output transistors in that channel and check the bias adjustment, the control and other parts in the network with an ohmmeter before inserting a new transistor. All output transistors in one channel will be destroyed if the base biasing circuit is open in the emitter end.

#### SAFETY INSTRUCTIONS

#### \* PRECAUTIONS DURING SERVICING

- 1. Parts identified by the symbol parts are critical for safety. Replace only with same parts number specified.
- Other parts and assemblies are specified for conformance with such regulations as those applying to spurious radiation. These must also be replaced only with replacements.
   Examples: RF converters, tuner units, RF cables, noise blocking capacitors, noise blocking filters, etc.
- 3. Use specified internal wiring
  - a) Primary leads
  - b) Wires covered with PVC tubing
  - c) Double insulated wire
- 4. Use specified insulating materials for hazardous live parts.
  - a) Insulation Tape
  - b) Insulated Barriers (Spacers)
  - c) PVC Tubing
  - d) Plastic screws for fixing microswitch (Especially in turntable)
  - e) Terminal strips

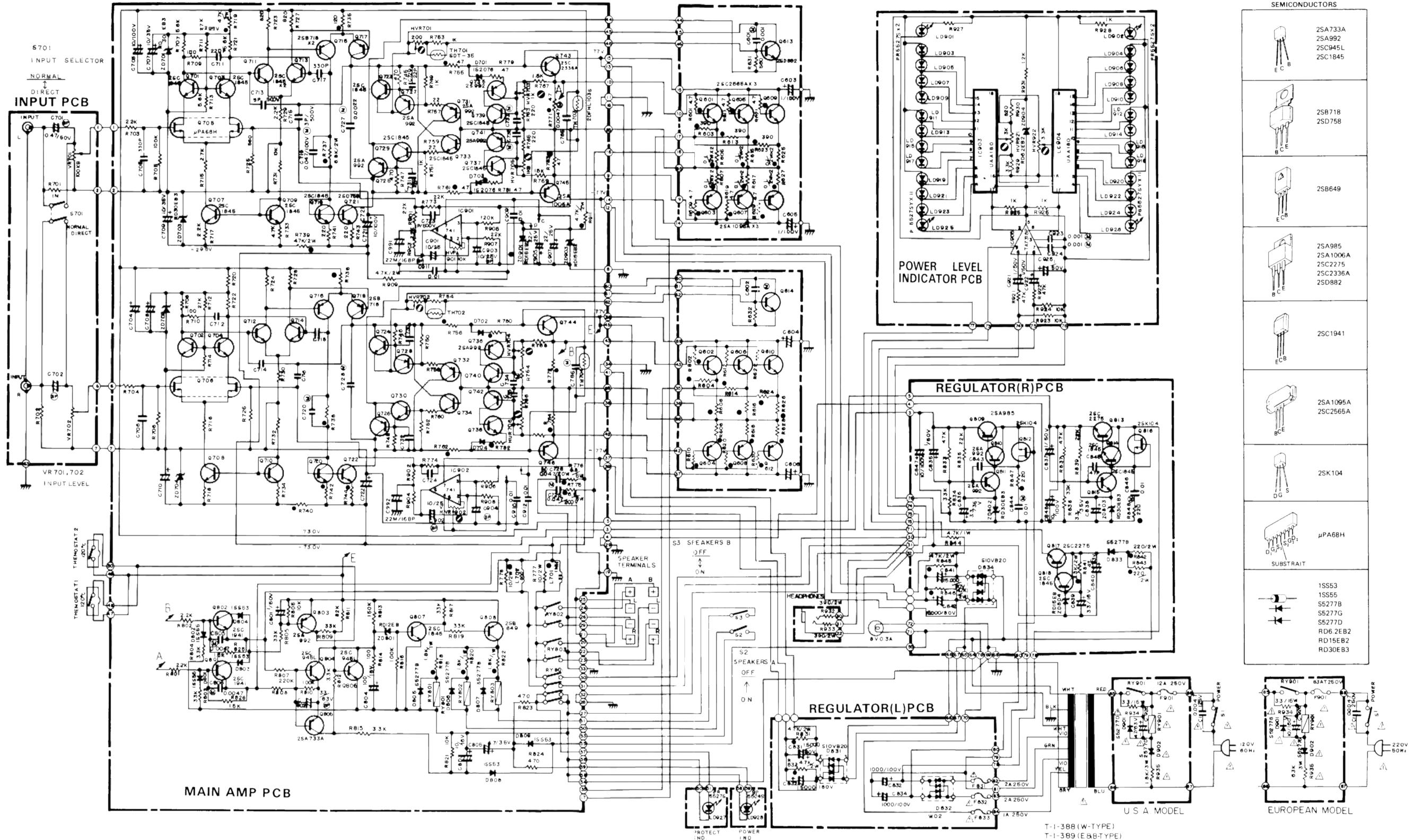
When replacing the primary components (transformer, power supply cord, switch, switch by-pass capacitor, etc.), wrap ends of wires securely about the terminals before soldering. Where hand soldering is involved a minimum spacing below between terminals of uninsulated live parts of primary or supply circuitry through air or over surface is to be maintained. 110V, 120V appliance: >3mm spacing

- 110V, 120V appliance : >3mm spacing 220V, 240V appliance : >6mm spacing
- 5. Observe that wires don't contact heat producing parts (heatsinks, oxide metal resistors, rectifiers, etc)
- 6. Check that replaced wires do not contact sharp edge or pointed parts.
- 7. Do not remain an electric conductive parts (screws, droplets, etc.) inside the appliance.

#### \* SAFETY RECHECK AFTER SERVICING

Confirm the specified insulation resistance between power plug prongs and externally exposed parts of the appliance is greater than  $10M\Omega$ , but for equipment with external antenna terminals (tuner, receiver, etc.) and is specified insulaton resistance should be more than  $2M2\Omega$  ({ground terminals, inoutput jacks, etc.).

# SCHEMATIC DIAGRAM



## NOTES:

1. SCHEMATIC IS SUBJECT TO CHANGE WITHOUT NOTICE.

## UNLESS OTHERWISE SPECIFIED:

- 2 RESISTANCE VARUES ARE IN OHMS. K = 1,000; M = 1,000,000
- 3. CAPACITANCE VALUES 1.0 AND ABOVE ARE IN pF OR  $\mu$ F (P = pF, M =  $\mu$ F), LESS THAN 1.0 ARE IN µF. (ELECTROLYTIC CAPACITANCE VALUES ARE IN \( \mu F/WV. \)
- 4. VOLTAGES ARE MEASURED TO CHASSIS GROUND WITH A "DC VOLTMETER".

# SCHEMATIC SYMBOLS: M POLYESTER FILM CAPACITOR

BDBIPOLAR CAPACITOR NONFLAMMABLE RESISTOR

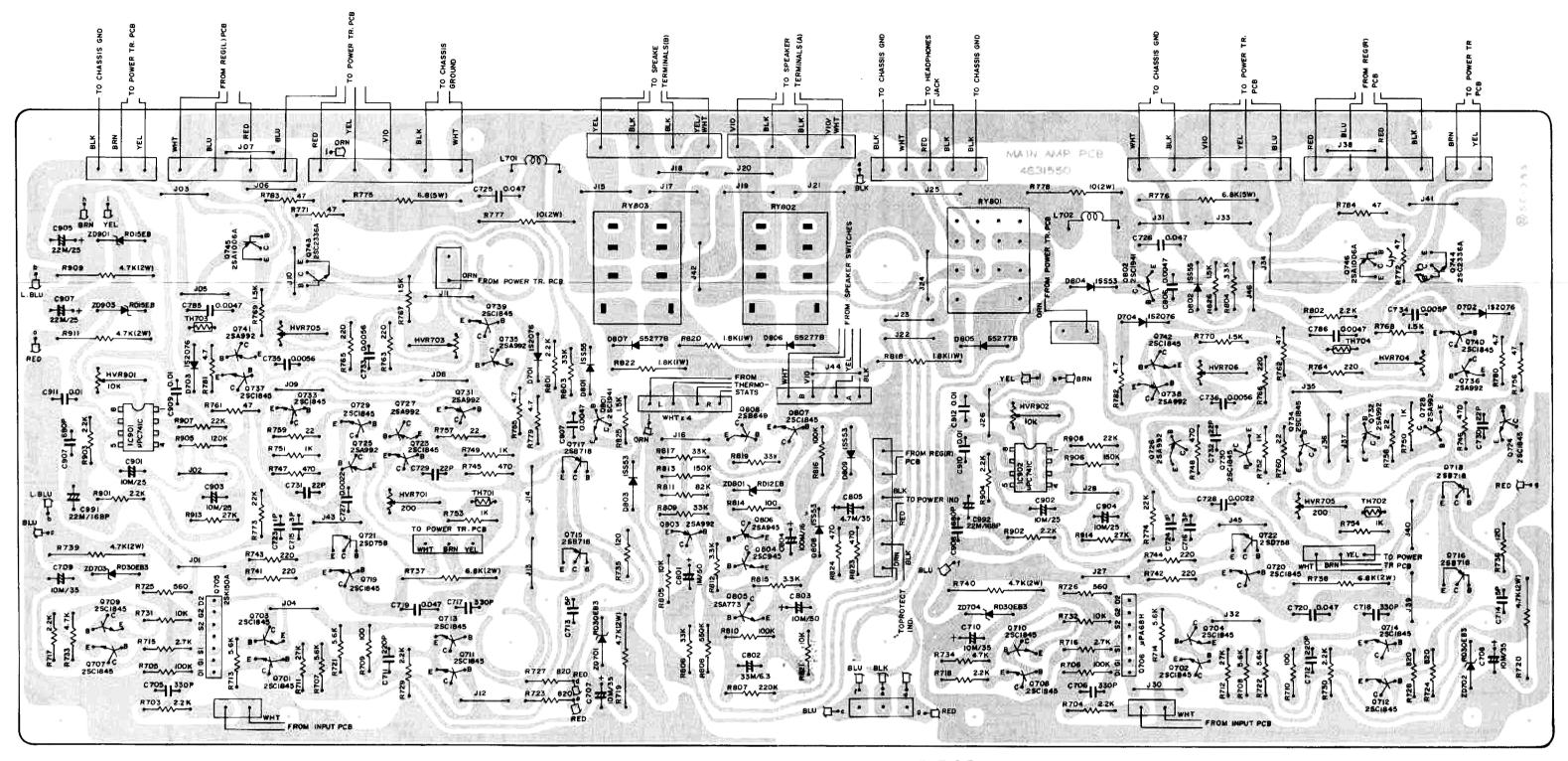
# SERVICE INFORMATION:

CAUTION: REFER SERVICING TO QUALI-FIED SERVICE PERSONNEL.

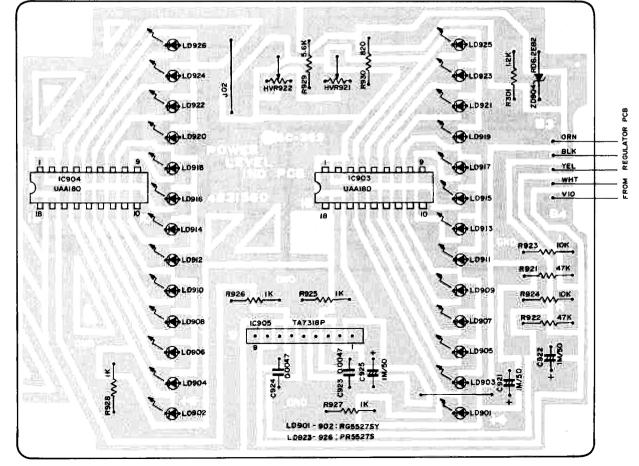
- 1. EACH PRECAUTION TO BE FOLLOWED DURING SERVICING.
- 2. \Lambda INDICATES SAFETY CRITICAL COMPONENTS FOR CONTINUED SAFETY. REPLACE SAFETY CRITICAL COMPO-NENTS ONLY WITH MANUFACTURER'S RECOMMENDED PARTS.
- 3. BEFORE RETURNING THIS APPLIANCE TO THE CUSTOMER, YOU MAKE LEAK-ARE-CURRENT OR RESISTANCE MEASUR-MENTS TO DETERMINE THAT EXPOSED PARTS ARE ACCEPTABLY INSULATED FROM THE SUPPLY CIRCUIT.

Figure 7

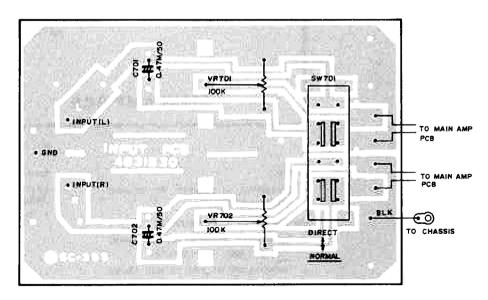
# P.C.BOARD (CONDUCTIVE SIDE VIEW) Figure 8



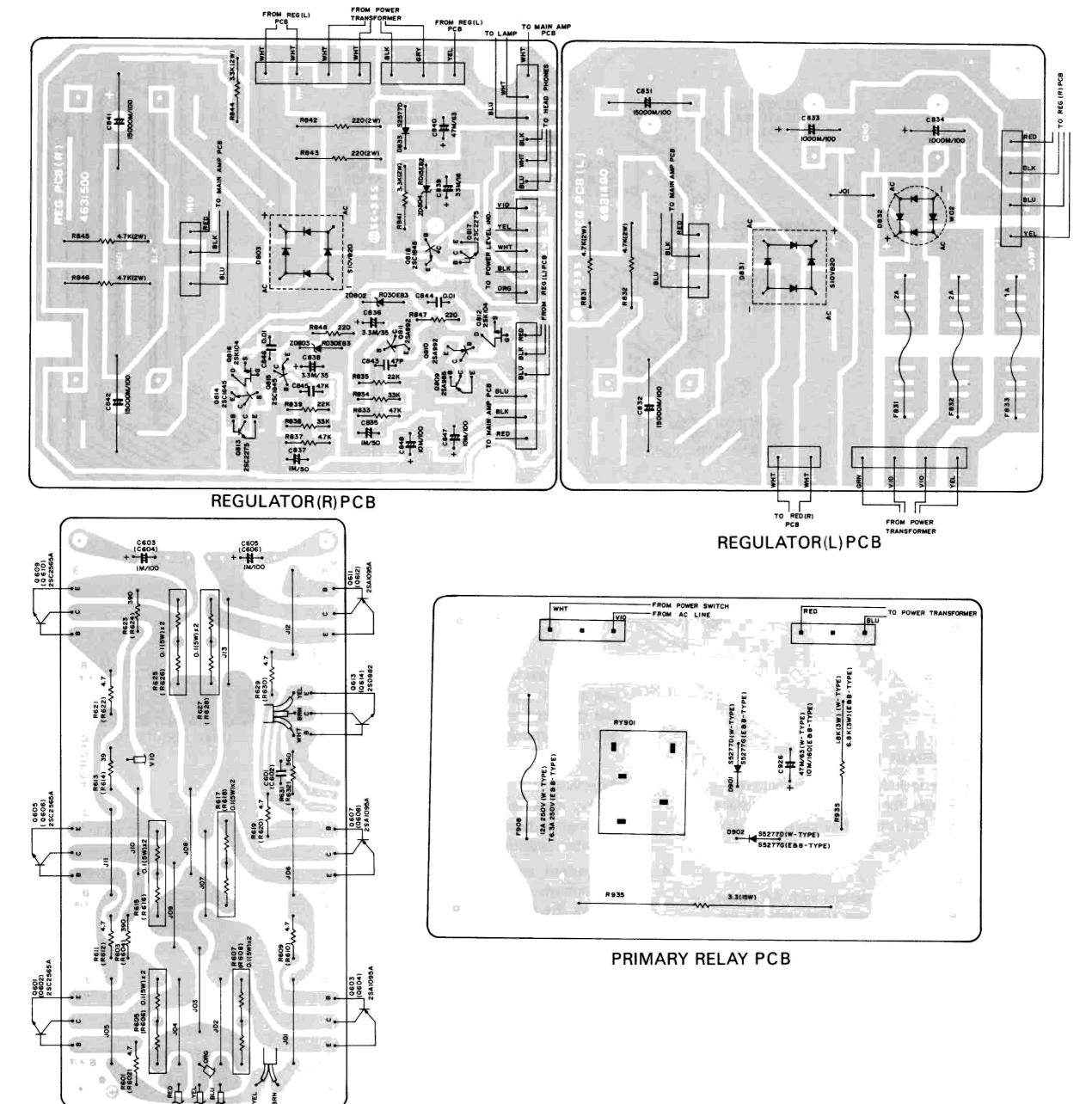
MAIN AMP PCB



POWER LEVEL IND. PCB



INPUT PCB



POWER TRANSISTORS PCB

## **PARTS LIST**

#### NOTES:

- 1.  $\star$  The KEY NUMBER ( # ) marked with a (  $\star$  ) on parts list relate to number of three digits with a ( ). (Photo 6  $\sim$  9)
- 2. + Numberals in file indicate the quantity of parts used in one type.

3. ++ TR: Transistor
FET: Field effec

FET: Field effect transistor
VR: Volume control (Variable resistor)
RES: Carbon film fixed resistor
MO-RES: Metal oxide film fixed resistor
CEM-RES: Cemented wirewound fixed resistor
FP: Flame proof

C-CAP: Flame proof

E-CAP: Aluminum electrolytic capacitor
M-CAP: Polyester film capacitor
S-CAP: Polystyrene film capacitor
T-CAP: Tantalum electrolytic capacitor
BP-CAP: Bipolar electrolytic capacitor

LC-CAP: Low current leakage electrolytic capacitor.

- 4. Assemblies and parts are subject to change without notice.
- 5. Parts ordering procedure:
  - A. DO NOT USE THE "KEY" NUMBER AND "SYMBOL" NUMBER. (these are control # for the factory only)
  - B. Include in any order
    - a. Part number.
    - b. Part description.
    - c. Model number,

(any of the above lacking from an order may delay shipment of that order.)

#### CAUTION:

The mark, the KEY NO. and the SYMBOL NO. circled with rectangle in the schematic diagram and the shaded are in the parts list designate components which have special characteristics important for safety and should be replaced only with types identical to those in the original circuit or specified in the parts list.

KEY	SYMBOL	TYPE+		PART	1	KEY	SYMBOL	TYPE+		PART
NO.	NO.	WEB	DESCRIPTION ++						DESCRIPTION ++	
110.		W L D		NO.	-	NO.	NO.	W E B		NO.
	PACKING	MATE	RIALS & ACCESSORIES			<b>*</b> 205		1 1 1	Switch, twin push — SUF-24 — speakers	4041040
001		1 1 1	Carton box	9826840		<b>★207</b> <b>★208</b>			Light guide, level indicator Lamp — 8V 0.3A	7401580
002		2 2 2		9840960	1	-200			Lamp – 8V U.SA	5808200
003			Sack, polyethylen cloth Sack, polyethylen cloth — #13	9640750	i					
005a			Manual, instructions — English and French	9640320 960432E	1					
005b			${\sf Manual, instructions-in \ five \ different}$					BACK	PLATE ASSEMBLY	
007a		1	languages Card, warranty – U.S.A.	960432K 967046A	1	<b>★</b> 301a		1	Plate, back — (W)	7000040
007b			Card, warranty — Canada	967044A	1	*301b			Plate, back — (E)	7328640 732865A
008			List, service stations	9690300	1					
009		1 1 1	Cord, RCA phono pin plug – 2T-1	962014A		★302		2 2 2	Block, terminal guard	7402130
		CABIN	IET ASSEMBLY			<b>★</b> 303		2 2 2	Knob - P2BK-1613DL - input level	7852350
					Á	<b>★</b> 304a			Cord, AC line - SPT-2	606008A
*101a *101b			Panel, front — SILVER Panel, front — BLACK	7886540 7886530	1-	*304b			Cord, AC line – CEE-2T	600511A
★102b			Panel, power level indicator – BLACK	7871320		★304c ★305a			Cord, AC line – BS Bush, power cord – SR-4N-4	600515A
			,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,	7071020		153300000000000000000000000000000000000			Bush, power cord — SR-6W-1	7400690 7400740
★103a ★103b			Handle – 120G – SILVER	7490360						
× 1030		2 2 2	Handle – 120B – BLACK	7490210		★306		1 1 1	Terminal, speakers — screw type 4P	4450490
<b>*</b> 104		1 1 1	Window, panel	7803210		<b>*3</b> 07		1 1 1	Shaft, GND terminal — MK-3	7152050
<b>*</b> 105		1 1 1	Spacer, LED	7002130	ĺ	<b>*</b> 308		1 1 1	Nut, GND terminal — MK-2	7152060
<b>*</b> 106			Globe, LED – protection indicator	7402540	1			(INPUT	PCB SECTION)	
<b>*</b> 107		1 1 1	Guide, button — 1P18 — power switch	7402550		<b>*</b> 309			Terminal BOA	
<b>★</b> 108			Guide, button – 2P18 – speakers selector	7402550	1	*309 *310			Terminal, RCA phono pin jack Switch, slide — SSB-042 — normal-direct	4442070
<b>*</b> 109			Globe, LED – input power indicator	7402120					selector	4020560
   ★110a		2 2 2	Butter Buck MICCI			<b>*</b> 311		2 2 2	VR 100kohm (B) — input level control	4310630
- 1104		3 3 3	Button, Push — M18GL — power/speaker, SILVER	7853940			C701,702	2 2 2	PRICAR D 47 FOV	0055050
<b>★</b> 110b		3 3 3	Button, push — M18BK — power/speaker,	7000040			R701,702		BP-CAP 0.47uf 50V RES 1meg.ohm 5% ¼W	225505C 328105J
			BLACK	7852300			,			3201033
<b>*</b> 111		1 1 1	Cover, top	7821090			PRI	MARY	RELAY PC BOARD ASSEMBLY	
112			Plate, bottom	7326250				(PRIMA	RY RELAY SECTION)	
<b>*</b> 113		4 4 4	Foot, polyethylen $-30\phi$ x14	7400780					<u> </u>	
					\ <u>\</u>		F901 F901		Fuse - 12A 250V MGC Midget fuse - T6.3A 250V	4700750
		CHASS	SIS ASSEMBLY				. 501		Wroget ruse = 10.3A 250 V	4720490
*201a		1	Transformer course T 1 200 A 2122	116000	Å		RY901		Relay - LY1-0-US TV-5	1700390
*201b			Transformer, power – T-1-388 – AC120V Transformer, power – T-1-389 – AC220 or	1103880	4		RY901	- 1 1	Relay - FRL-264D100	1700400
			240V	1103890	Δ		D901,902	2	Diode S5277D	560047S
+202					Δ		D901,902		Diode S5277G	5600698
*202a *202b			Switch, push — ESB-99354T — power	4041830	Δ					
203a			Switch, push — ESB 90179S — power C-CAP 0.0047uf	4041600 239472A			C926		E-CAP 47uf 63V	2116250
204			Cover, C-CAP	7400960			C926 C934		E-CAP 10uf 160V CEM-RES 3.3ohm 10% 15W	261120Q 387338U
			·						10% 15%	3673360

KEY	SYMBOL	TYPE <sup>†</sup>	PART
		DESCRIPTION++	NO.
NO.	NO.	W E B	
	R935 R935	1 FP-MO-RES 1.8kohm 5% 3W - 1 1 FP-MO-RES 6.8kohm 5% 3W	<b>36</b> 318 <b>2</b> L 363682L
		(INPUT POWER INDICATOR SECTION)	
	LD928	1 1 1 LED BR5504S 1 1 1 Spacer, LED	5060300 7903140
		(PROTECTION INDICATOR SECTION)	
	LD927	1 1 1 LED PR5527S 1 1 1 Spacer, LED	5060270 7903270
		(HEADPHONES SECTION)	
<b>*</b> 401	R932,933	1 1 1 Jack, headphones 2 2 2 FP-MO-RES 390ohm 5% 2W	4550260 3623911
	POWER T	RANSISTORS PC BOARD ASSEMBLY - LEFT CHANNEL ONLY	
	Q601,605, Q609	3 3 3 TR 2SC2565A (R or O or Y)	5121179
	Q603,607 Q611	3 3 3 TR 2SA1095A (R or O or Y)	5101175
	Q613	1 1 1 TR 2SD882 (P or Q)	5131195
		1 1 1 Thermostat — OHD-120M	4900945
	C603,605 C601	2 2 2 E-CAP 1uf 100V 1 1 1 M-CAP 0.001uf 10% 50V	2118100 2221021
	R601,609		
	R611,619, R621,629 R603,613,	6 6 6 FP·RES 4.7ohm 5% %W	3284781
	R623	3 3 3 FP-RES 390ohm 5% ¼W	3283911
	R631 Others	1 1 1 RES 5600hm 5% ¼W 6 6 6 CEM-RES 0.10hm 10% 2Wx2	328561J 382109F
	MAIN	AMP PC BOARD ASSEMBLY	
	L701,702	1 1 1 Coil, choke — 1uH	1210960
	IC901,902	2 2 2 IC μPC741C	518088
	Q701		
	~ Q704 Q705,706	4 4 4 TR 2SC1845 (E or F) 2 2 2 FET μPA68H (L)	5121159 5160509
	Q707 ~ Q714 Q715	8 8 8 TR 2SC1845 (E or F)	512115
	~ Q718	4 4 4 TR 2SB718 (C)	5111179
	Q/19,/20 Q721,722	2 2 2 TR 2SC1845 (E or F) 2 2 2 TR 2SD758 (C)	5121159 5131209
	Q723,724 Q725		512115
	~ Q728	4 4 4 TR 2SA992 (E or F)	510110
	Q729,730		5121159
	Q731,732 Q733	2 2 2 TR 2SA992 (E or F)	5101108
		6 6 6 TR 2SC1845 (E or F)	5121159
	Q743,744 Q745,746	2 2 2 TR 2SC2336A (P, Q) 2 2 2 TR 2SA1006A (P, Q)	5121519 5101369
	D701 ~ D704	4 4 4 Diode 1S2076	5010198
		4 4 4 Zener diode RD30EB3 2 2 2 Zener diode RD15EB2	5020669 5020509
		2 2 2 Thermistor SDT-35	
	111/01,/02	2 2 2 Hermistor 201-22	5400190

KEY	SYMBOL	T`	/PE	+		PART
NO.	NO.	W	Ε	В	DESCRIPTION <sup>++</sup>	NO.
	TH703,704	2	2	2	Thermistor D2FHL-103S	5400180
	C703,704	2	2	2	E-CAP 10uf 100V	2118200
	C705,706 C707	2			C-CAP 330p 10% 50V SL	232331K
	~ C710	4	4	4	E-CAP 10uf 35V	211420Q
	C711,712				C-CAP 220pf 10% 50V SL	232221K
	C713,714				C-CAP 5pf ± 0.5pf 500V SL	234509D
	C715,716				C-CAP 3pf ± 0.5pf 500V SL C-CAP 330pf 10% 50V SL	237309D 232331K
	C717,718				C-CAP 330pf 10% 50V SL M-CAP 0.047uf 10% 100V	232331K 226473K
	C719,720 C721,722				E-CAP 10uf 100V	2118200
	C723,724				C-CAP 1pf ± 0.5pf 500V SL	234109D
	C725,726				M-CAP 0.047uf 10% 200V	272473K
	C727,728				M-CAP 0.0022uf 10% 50V	222222K
	C729 ~ C732	4	4	4	C-CAP 22pf 10% 50V SL	232220K
	C733 ~ C736	4	4	4	M-CAP 0.0056uf 10% 50V	222562K
	C785,786 C901	2	2	2	M-CAP 0.047 uf 10% 100 V	226473K
	~ C904	4	4	4	BP-CAP 10uf 25V	215320C
	C905,907 C909				E-CAP 22uf 25V	211322Q
	~ C912	4	4	4	C-CAP 0.01uf +80, -20% 50V YG	231103Z
	C991,992	1	1	1	BP-CAP 22u 16V	215222C
					Potentiometer – 200ohm	4301290
					Potentiometer — 1kohm	4301300
	HVR901,90	22	2	2	Potentiometer – 10kohm	4301280
	R703,704				RES 2.2kohm 5% ¼W	328222J
	R705,706	2			RES 100kohm 5% ¼W	328104J
	R707,708 R711	2	2	2	RES 5.6kohm 5% ¼W	328562J
	~ R714				RES 27kohm 5% ¼W	328273J
	R715,716	2			RES 2.7kohm 5% ¼W	328272J
	R717,718				RES 2.2kohm 5% ¼W	328222J
	R719,720	2			FP-MO-RES 4.7kohm 5% 2W	362472L
	R721,722 R723,724	2			RES 5.6kohm 5% ¼W RES 820ohm 5% ¼W	328562J 328821J
	R725,724				RES 560ohm 5% ¼W	328561J
	R727,728	2			RES 820ohm 5% ¼W	328821J
	R729,730				RES 2.2kohm 5% ¼W	328222J
	R731,732	_	_	_	RES 10kohm 5% ¼W	328103J
	R733,734				RES 4.7kohm 5% ¼W	328472J
	R735,736	2	2	2	FP-RES 120ohm 5% ¼W	328121L
	R737,738	2	2	2	FP-MO-RES 6.8kohm 5% 2W	362682L
	R739,740 R741	2	2	2	FP-MO-RES 4.7kohm 5% 2W	362472L
	~ R744 R745	4	4	4	FP-RES 220ohm 5% ¼W	328221L
	~ R748 R749	4	4	4	RES 470ohm 5% ¼W	328471J
	~ R752				RES 1kohm 5% ¼W	328102J
	R755,756 R757	2	2	2	FP-RES 47ohm 5% ¼W	328470L
	~ R760				RES 22ohm 5% ¼W	328220J
	R761,762 R763	2	2	2	FP-MO-RES 47ohm 5% ¼W	328470L
	~ R766 R767	4	4	4	RES 220ohm 5% ¼W	328222L
	~ R770	4	4	4	RES 1.5kohm 5% ¼W	328152J
	R771,772				FP-MO-RES 150ohm 5% 1W	361150L
	R777,778				FP-MO-RES 10ohm 5% 2W	362100L
	R775,776	2	2	2	CEM-RES 6.8ohm 10% 5W	384688K
	R797,798 R901	2	2	2	RES 22kohm 5% ¼W	328223J
	~ R904				RES 2.2kohm 5% ¼W	328222J
	R905,906				RES 120kohm 5% ¼W	328124J
	R907,908				RES 22kohm 5% ¼W	328223J
	R909,911	2	2	2	FP-MO-RES 4,7kohm 5% 2W	362472L

KEY	SYMBOL	TYPE+	PART
NO.	NO.	DESCRIPTION <sup>++</sup> W E B	NO.
		(PROTECTOR SECTION)	
	RY801	1 1 1 Relay – DC48V	1700380
	RY802,803	2 2 2 Relay – DC48V	1700330
		4 4 4 Magnet — 1285	7903170
	Q801,802	2 2 2 TR 2SC1941 (L or K)	5121129
	Q803	1 1 1 TR 2SA992 (E or F)	5102203
	Q804,806	2 2 2 TR 2SC945L (P or Q)	5150778
	Q805	1 1 1 TR 2SA733A (P or Q)	5140749
	Ω807	1 1 1 TR 2SC2240 (BL)	5121169
	Q808	1 1 1 TR 2SB649 (B or C)	5111119
	D801,802	2 2 2 Diode 1SS55	5010245
	D803,804	2 2 2 Diode 1SS53	501023
	D805		
	~ D807	3 3 Diode S5277B	5600469
	D808,809	2 2 2 Diode 1SS53	5010239
	ZD801	1 1 Zener diode RD12EB3	5020589
	C801	1 1 1 E-CAP 1uf 50V	2115100
	C802	1 1 1 BP-CAP 33uf 6.3V	2150530
	C803,804	2 2 2 E-CAP 100uf 16V	2112300
	C805	1 1 1 E-CAP 10uf 50V	2115200
	C806	1 1 1 E-CAP 4.7uf 35V	2114150
	REGULAT	OR (L) PC BOARD ASSEMBLY	
	F021 022	2 5 24 2507 4400	
	F831,832 F833	2 Fuse - 2A 250V MGC 1 Fuse - 1A 250V MGC	4700620 4700590
	1 000	1 1 dae - 1A 230V MGC	4700590
	F831,832	- 2 2 Midget fuse - T2A 250V	4720370
	F833	- 1 1 Midget fuse - T1A 250V	4720330
	D021	1 1 1 0: 010//000	5000500
	D831	1 1 1 Diode S10VB20	5600589
	D832	1 1 1 Diode W02	5600613
	C831,832	2 2 2 E-CAP 15000uf 100V	2100100
	C833,834	2 2 2 E-CAP 1000uf 100V	2100110
	R813,832	1 1 1 FP-MO-RES 4.7kohm 5% 2W	3624721
	REGULAT	OR (R) PC BOARD ASSEMBLY	
	Q809	1 1 1 TR 25A985 (P or Q)	5101189
		2 2 2 TR 2SA992 (E or F)	5101103

KEY	SYMBOL	TY	PE +	DESCRIPTIO	N ++		PART
NO.	NO.	W	ΕВ	D 2001111 110			NO.
	Q812	1	1 1	FET 2SK104 (F)			516026S
	Q813	1	1 1	TR 2SC2275 (P or Q)			512120S
	Q814,815	2	2 2	TR 2SC1845 (E or F)			512115S
	Q816	1	1 1	FET 2SK104 (F)			516026S
	Ω817		1 1				5121208
	Q818		1 1	TR 2SC1845 (E or F)			512115S
	D802,803	2	2 2	Zener diode RD30EB3			502066S
	D804	1	1 1	Zener diode RD15EB2			502050S
	D833	1	1 1	Diode S5277B			560046S
	D834	1	1 1	Diode S10VB20			560058S
	C835,837	2	2 2	E-CAP 1uf 50V			211510Q
	C836,837			E-CAP 3.3uf 35V			211413Q
	C839	1	1 1	E-CAP 33uf 16V			211223Q
	C840	1	1 1	E-CAP 47uf 63V			211625Q
	C841,842	2	2 2	E-CAP 15000uf 100V			2100100
	R833,837	1	1 1	RES 47kohm	5%	¼W	328473J
	R834,838	1	1 1	RES 33kohm	5%	1/4W	328333J
	R835,839	1	1 1	RES 22kohm	5%	¼W	328223J
	R841	1	1 1	FP-MO-RES 3.3kohm	5%	2W	362332L
	R842,843	2	2 2	FP-MO-RES 220ohm	5%	2W	362221L
	R844	1	1 1	FP-MO-RES 4.7kohm	5%	1W	361472L
	R845,846	2	2 2	FP-MO-RES 4.7kohm	5%	2W	362472L
	POWER	LEV	EL	INDICATOR PCB AS	SEIVIR	LY	
					020		
	1C903,904	2	2 2	IC UAA180			518066S
	IC905	1	1 1	IC TA7318P			518067S
	ZD904	1	1 1	Zener diode RD6.2EB2			502048S
	LD901						
	~ LD922	22 2	2 22	LED PG5527SY - green			5060280
	LD923			3			***************************************
	~ LD926	4	4 4	LED PR5527S - red			5060270
	C921,922	2	2 2	E-CAP 1uf 50V			211510Q
	C923,924	2	2 2	M-CAP 0.0047uf 10%	50V		222472K
	C925			E-CAP 1uf 50V			211510Q
	HVR921,92	222	2 2	Potentiometer – 3kohm			4301340
	R921,922	2	2 2	RES 47kohm	5%	¼₩	328473J
	R923,924	2	2 2	RES 10kohm	5%	¼W	328103J
	R925			P.F.O. 41			
	~ R928	4		RES 1kohm	5%	¼W	328102J
	R929		1 1		5%	1/4W	328820J
	R930		1 1	RES 3.3kohm	5%	¼W	328322J
	R931	1	1 1	RES 1.2kohm	5%	1/4W	328122J

## **SEMICONDUCTOR DATA**

**TRANSISTORS** 

† NOTES Ge: Germanium A : Alloy Df : Drift-field M : Mesa Si : Sillicon B : Base E : Epitazial P : Planer D : Diffused G : Grown Pc : Point-contact Dd : Double-diffused J : Junction Td : Triple-diffused

				TA = 25°C u	nless otherw	te-Maximum vise specified	Values: I)						ERISTICS T	[ypical	Value	s: (T <sub>A</sub> = 2	25°C u	nless oth	ierwise spec	rified)	
DEVICE	APPLICATIONS	STRUC- TURET	Collector- to-Bace Voltage	Emitter- to-Bace Voltage	Collector Current	Collector Dissipa- tion	Junction Tempera- ture	Collector ( Currer			orward-C nsfer Rat		Collector Saturatio			Gain-Band f <sub>T</sub>	VCE	roduct	Output Capaci- tance	Others	MANU-
		TONE	VCBO (V)	VEBO (V)	IC (mA)	Pc (mW)	T」 (°C)	ICBO (uA)	VcB (v)	peE	VCE (V)	IC (mA)	VCE(sat)	IC (mA)	lB (mA)	fab* (MHz)	V <sub>CB</sub> •	IC*	Cob (pF)		FACTORER
2SA733A (P, Q)	AF, General	PNP Si-E	60	-5	-100	250	125	-0.1 max.	-60	135 ~ 400	-6	-1	-0.3 max.	-100	- 10	450 max.	-6	10	6 max,		NEC
2SA985 (P, Q)	AF, Power, amp.	PNP Si-E	- 120	-5	-1.5A	25W (T <sub>C</sub> =25°C)	150	-1 max.	- 120	100 ~ 320	-5	-300	-2 max.	-1A	-100	180	5	- 200°	29	Complementary to 2SC2275	NEC
2SA992 (E, F)	AF, Low noise	PNP Si-E	120	-6	-50	500	125	-0.05 max.	-120	300 ~ 800	-5	1	- 0.3 max.	-10	-1	100	-6	1	3 max,	Complementary to 2SC1845	NEC
2SA1095A (R, O, Y)	AF, Power amp.	PNP Si-E	- 180	- 5	- 15A	150W (T <sub>C</sub> =25 °C)	150	– 50 max,	-160	55 ~ 240	5	-1A	-2 max.	-5A	-500	60	- 10	-1A*	350	Complementary to 2SC2565A	TOSHIBA
2SB649 (B, C)	AF, Driver	PNP Si-E	-180	- 5	1.5A	20W (T <sub>C</sub> -25 C)	150	10 max.	- 160	60 ~ 200	. 5	- 150	-1 max.	-500	- 50	140	-5	150*	27		HITACHI
2SA1006A	PA	PNP Si-E	-200	-5.0	1.5	25W (T <sub>C</sub> =25 C)	150	-1	-150	100 ~ 320	-5.0	- 150	-0.4	- 500	50	80	- 10	-0.1A		Complementary to 2SC2336A	NEC
2SB718 (C)	AF, Driver	PNP Si-E	200	-5	- 50	1250	150	-10 max.	160	100 ~ 200	-5	-10	−2 max.	30	-3	140	-5	10*	5.5	Complementary to 2SD758	нітасні
2SC945L (P, Q)	AF. General	NPN Si-E	60	5	100	250	125	0.1 max.	60	135 ~ 400	6	1	0.3 max.	100	10	450 max.	6	-10	5 max,		NEC
2SC1845 (E, F)	AF, Low noise	NPN Si-E	120	5	50	500	125	0.05 max.	120	300 ~ 800	6	1	0,3 max.	01	1	110	6	1	2.5 max.	Complementary to 2SA992	NEC
2SC1941 (L, K)	AF, Driver	NPN Si-E	160	5	50	800	150	0,1 max.	160	135 ~ 400	10	1	0.6 max.	20	2	120	10	-10	3 max,		NEC
2SC2275 (P, Q)	AF, Power amp.	NPN Si-E	120	5	1.5A	25W (T <sub>c</sub> -25°C)	150	t max.	120	100	5	300	2 max.	1A	100	200	5	200*	19	Complementary to 2SA985	NEC
2SC2565A (R, O, Y)	AF, Power amp,	NPN Si-E	180	5	15A	150W (T <sub>C</sub> =25 C)	150	50 max.	160	55 ~ 240	5	1A	2 max.	5A	500	80	10	1A*	200	Complementary to 2SA1095A	TOSHIBA
2SC2336A		NPN Si-E	200	5.0	1.5	25W (T <sub>C</sub> -25°C)	150	1,0	150	100 - 320	5.0	150	0.3	500	50	95	10	0.1A		Complementary to 2SA1006A	NEC
2SD758 (C)	AF, Driver	NPN Si-E	200	5	50	1250	150	10 max.	160	100 ~ 200	5	10	2 max.	30	3	140	5	10*	3.8	Complementary to 258718	HITACHI
2SD882 (P, Q)	AF	NPN Si-E	40	5	3A	10W (T <sub>C</sub> =25 C)	150	1	30	100 ~ 320	2	20	0.5 max.	2A	200	90	5	-100	45		NEC

#### FIELD EFFECT TRANSISTOR

						bsolute- otherwi		n Values: ied)			ELEC	TRIC	AL CHARA	CTER	ISTICS Ty	pical \	/alues: (T <sub>A</sub>	- 25°	C unless o	therwis	e specified)				
DEVICE TYPE	APPLICA-	311100		Source	Current			Channel Temper- ature	Gate Le Curren		Gete to D Breakdo Voltag	wn	Drain Cu	rent	Gate to So Cutoff Vo		Forward Tr Admitta		Feed Ba Capacita		Power G (Common \$		Noise Fig	ure	MANU-
			VGDO (V)	VGSO (V)	lg (mA)	ID (mA)	PD (mW)	T <sub>ch</sub> (°C)	Test Conditions	IGSS ( nA)	Test Conditions	VIBRI) GDO (V)	Test Conditions	IDSS (mA)	Test Conditions	VGS (off) (V)	Test Conditions	iVrei (mg)	Test Conditions	Crss (pF)	Test Conditions	Ges (dB)	Test Conditions	NF (dB)	
⊭PAG8H (L)	AF, Low noise Differential amp.	Si N-channel junction (Dual)	-50	-50	10		200/ unit	125	V <sub>GS</sub> = -30v V <sub>DS</sub> =0	~1 max.			V <sub>DS</sub> =10V V <sub>GS</sub> =0	2.6 ~6.5			VDS=10V VGS=0 f=1 kHz IDSS= 3mA	12	VDG=10V ID=0 f=1 MH2	3			V <sub>DS</sub> =10V Rg=1 kΩ ID=1 mA f=1 kHz		TOSHIBA

#### DIODES, LED'S

					MAXIMI (1	JM RATH	NGS Abs	olute - Ma therwise s	ximum V pecified)	alues:			ELE	CTRICA	L CHARA	CTERIS	TICS Typica	al Values:	
DEVICE	APPLICATIONS	STRUCTURE	Reverse Surge	Peak Reverse	Reverse Voltage			Rectified		Junction Temperature		Forwa	rd Current Test	Forwar V=max	d Voltage Test	Rever	se Current Test	Others	MANU-
			Voltage VRsurge (V)	Voltage VRM (V)	VR (V)	Voltage VFM (V)	IFM (mA)	Current IO (mA)	Current IF surge (A)	T <sub>J</sub>	PD (mW)	(mA)	Condition VF (V)	(V)	Condition IF (mA)	(uA)	Condition VR (V)		FACTURER
15553	Medium speed switching	Sı-EP	\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\	35	30	107	300	100	2	200	500	(mA)	101	0.8	1.0 30	0.1	30		NEC
15555	Medium speed switching	Si-EP		100	75		300	100	2	200	500			0.8	1.0 30	0.1	75		NEC
\$5277B	Rectifier	Si-DJ		100			2.0A	1.0A	50A	150				1.2	1.0A	10	100		TOSHIBA
\$5277D	Rectifier	Si-DJ		200			2.0A	1.0A	50A	150				1.2	1.0A	10	200		TOSHIBA
S5277G	Rectifier	Si-DJ		400			2.0A	1.0A	50A	150				1.2	1,0A	10	400		TOSHIBA
W02	Rectifier	Si-DJ (Bridge)			200	200		1.5A	50	125				1.0	1.0A	10		Rth - 50°C/W	GENERAL INSTRUMENT
S10VB -20	Rectifier	Si-DJ (Bridge)		200				10A	200	150				1.05		10			SHINDENGEN
PR -5527S	Lamp (red)	Gap			4		100	l <sub>F</sub> = 30		85	75			2.5	10	100	4	ly= 1.2 mcd (lp=10 mA)	STANLEY
PR -5527SY	Lamp (green)	Gap			4		100	l F - 50		85	125			2.5	20	100	4	lv = 8 mcd (lr = 20 mA)	STANLEY
8R -5504S	Lamp (red)	GaAIAS			4		300	lF-50		85	100			2.0	20	100	4	lv - 80 mcd (l <sub>F</sub> = 20 mA)	STANLEY

#### ZENER DIODES

ZEIV!	יטוט חב	JEO																			
			Absolu	CIMUM RATI te Maximum unless otherw	Values:		ELECTRICAL CHARACTERISTICS Typical Values: (TA * 25°C unless otherwise specified)														
DEVICE TYPF	APPLICATIONS	STRUCTURE T	Total Power Dissipation	Zener Current	Junction Temperature		Zener Vz	Voltage	Test			Resistance Test			Coefficient		se Current Test	Others	MANU. FACTURER		
	1		į i		_				Conditions			Conditions	_		Conditions		Conditions		ľ		
			PD (mW)	IZ (A)	(°C)	MIN (V)	TYP (V)	MAX (V)	(mA)	TΥP (Ω)	MAX	Iz (mA)	TYP (%√°C)	MAX (%/°C)	(mA)	MAX (µA)	VR (V)				
RD6,2 EB2	Regulator	Si-J	400		175	5.96		6.27	20		20	20				5	3		NEC		
RD15- EB2	Regulator	Si-J	400		175	13.89		14.62	10		30	10	_			2	11		NEC		
RD30 EB3	Regulator	Si-J	400		175	28.36		29.82	5		130	5				2	23	·	NEC		

#### INTEGRATED CIRCUITS µPC741C

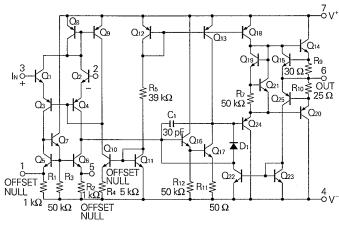
ABSOLUTE	MAXIMUM	RATINGS

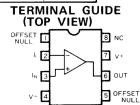
Supply Voltage	Input Voltage ±15 V
Internal Power Dissipation 350 mW	Storage Temperature Range –40°C to +125°C
Differential Input Voltage	Operating Temperature Range20°C to +75°C

**ELECTRICAL CHARACTERISTICS** ( $V_{CC} = \pm 15V$ ,  $T_A = +25^{\circ}C$  unless otherwise noted.)

PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS
Input Offset Voltage	R <sub>S</sub> ≤ 10 kΩ		1.0	6.0	mV
Input Offset Current			20	200	nA
Input Bias Current			80	500	nA
Large-Signal Voltage Gain	$R_L \geqslant 2 k\Omega$ $V_{out} = \pm 10V$	108	106		dB
Output Voltage Swing	R <sub>L</sub> ≥ 10 kΩ	12	±14		V
Common Mode Rejection Ratio	R <sub>S</sub> ≤ 10 kΩ	70	90		dB
Supply Voltage Rejection Ratio	$R_S \leq 10  k\Omega$		30	150	μV/V
Power Consumption			45	85	mW

#### **EQUIVALENT CIRCUIT**

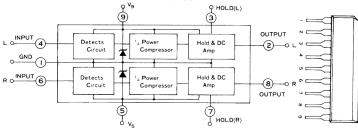




# INTEGRATED CIRCUITS TA7318P FUNCTION/MANUFACTURER

■ Dual Linear-to-Log Converter for Peak Power Indicator/Toshiba

BLOCK DIAGRAM AND CONNECTION INFORMATION  ${}_{\diamondsuit}{}^{\lor_9}$ 



#### INTEGRATED CIRCUITS UAA180

FUNCTION/MANUFACTURER

Analog-to-Digital Converter; 12 LED Driver/Siemens

BLOCK DIAGRAM AND CONNECTION INFORMATION

